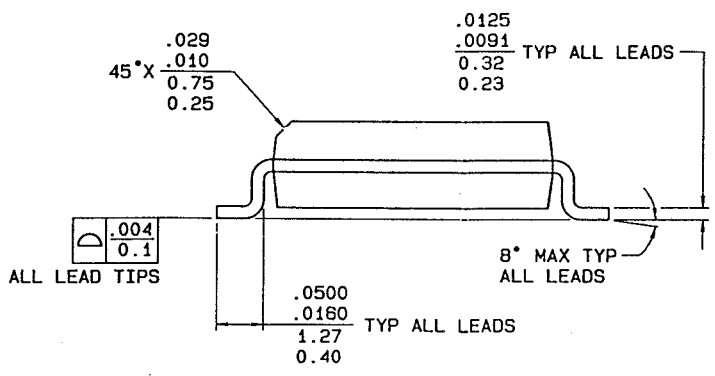
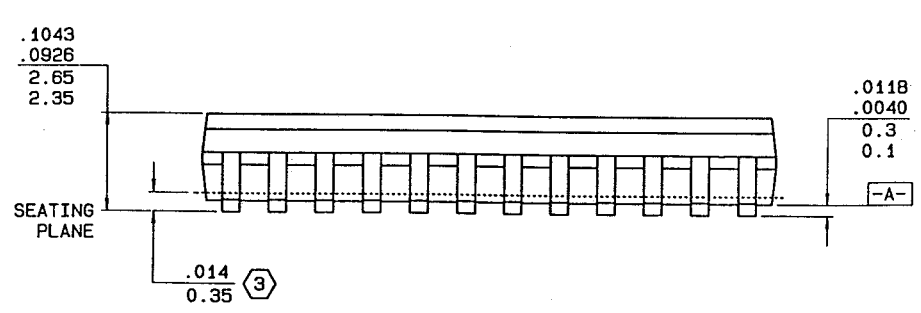
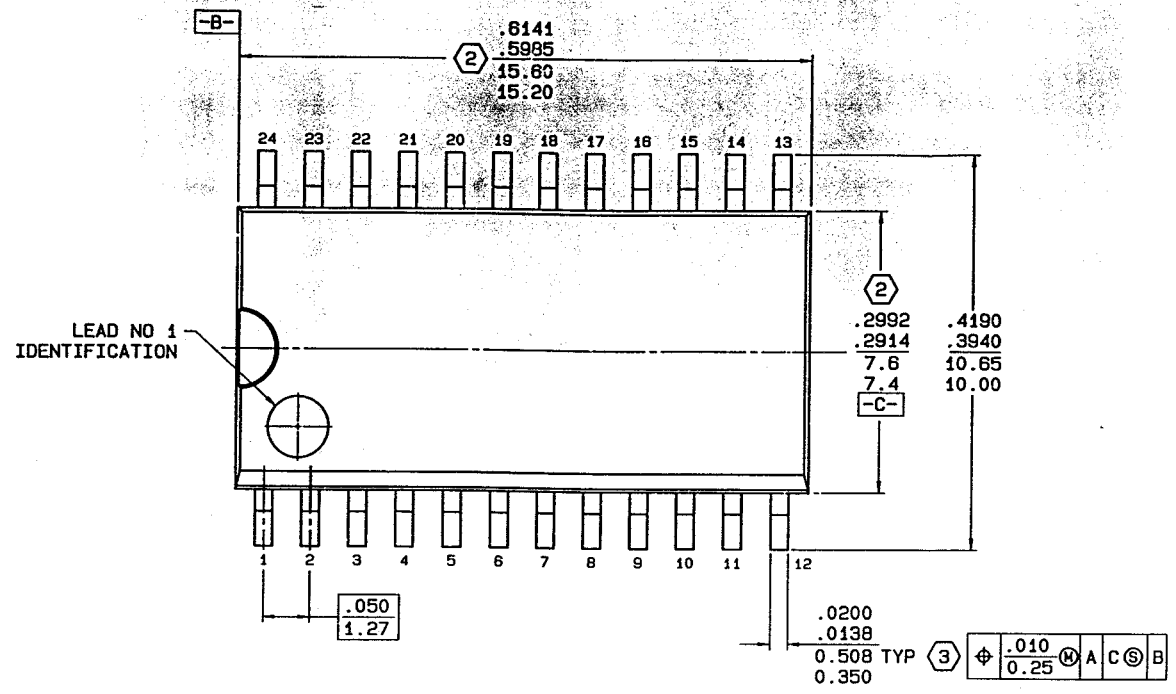


REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
D	REVISED AND REDRAWN	04105	02/17/87	JIM/PN
E	INCORPORATE NSC & FSC DWG REVISE DIM'S & NOTES	05929	05/04/88	TL/CC
F	REMOVE LEAD TAPER; DEL. NOTE 4.	07885	04/05/90	SLG/CC/L



- NOTES: UNLESS OTHERWISE SPECIFIED
- STANDARD LEAD FINISH: 200 MICROINCHES/5.08 MICRONS MINIMUM LEAD/TIN (SOLDER) ON COPPER.
 - THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH.
 - MAXIMUM LEAD WIDTH ABOVE AREA SPECIFIED .024/0.609.

APPROVALS	DATE	 NATIONAL SEMICONDUCTOR CORPORATION 2900 Semiconductor Drive, Santa Clara, CA 95052-8090		
DRAWN JIM WINNETT	02/17/87			
CHKD. C. Kelly	04/16/90			
ENGR. C. P. Pina	4/16/90			
APPROVAL		MOLDED PACKAGE, S.O., .300 WIDE, 24 LEAD		
PROJECTION	SCALE	SIZE	DRAWING NUMBER	REV
	N/A	C	MKT-M24B	F
DO NOT SCALE DRAWING		SHEET 1 OF 1		